



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



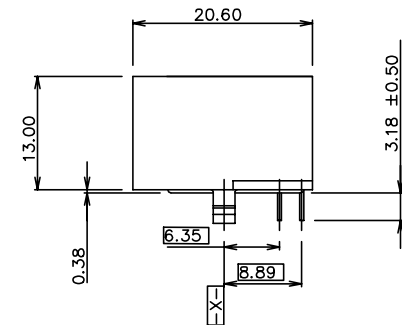
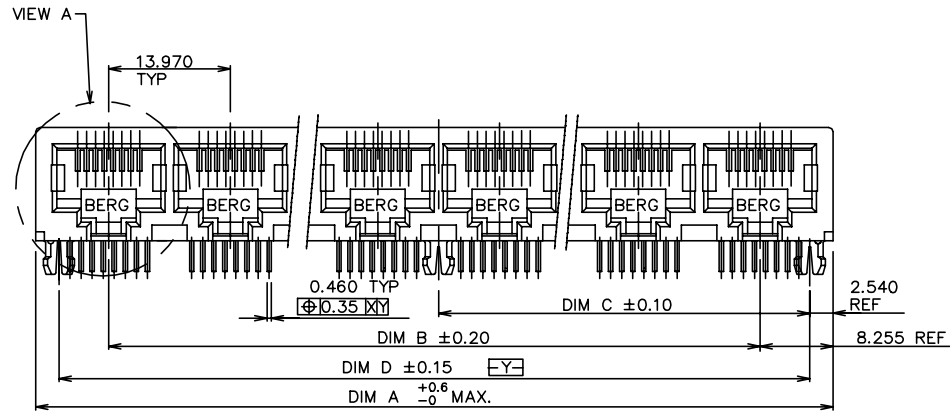
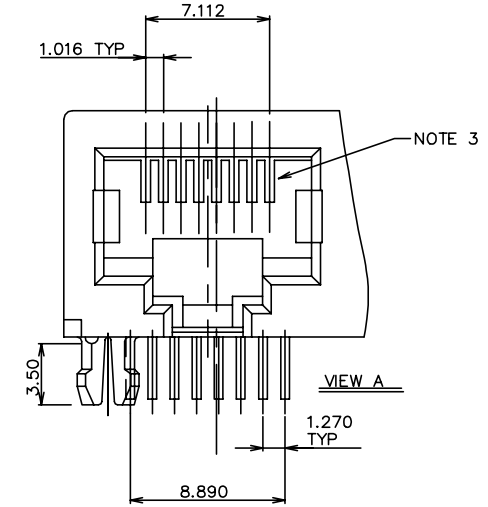
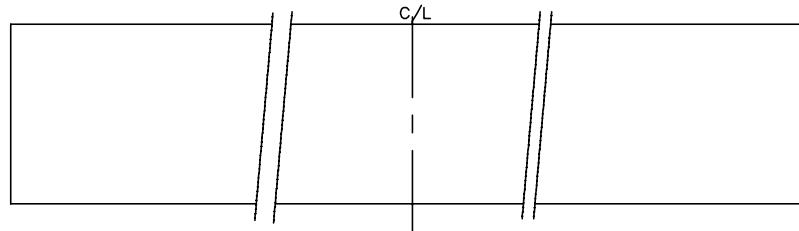
## Contact us

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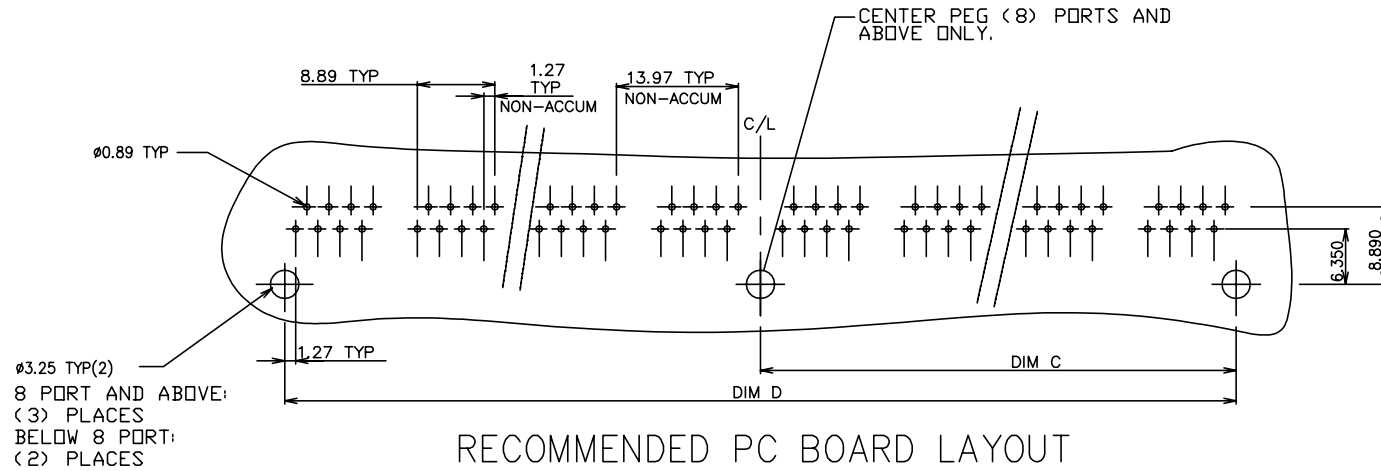


mat'l. code		surface ISO 1301 ✓		tolerance ISO406 ISO1101		projection ISO 10		product family MOD JACK	
ltr ecn nodr		date		tolerances unless otherwise specified		mm		title	
E	M04-0174 MTH	8/17/04	angle	0.X±0.3				R/A CAT5 GANG JACK ASSY	
F	M04-0187 MTH	10/06/04	1/16"	0.XX±0.13				8 POS UNSHIELDED SNAP PEG	
G	M05-0067 MTH	4/8/05	0°±2'	0.XXX±0.051		scale 1.0			
H	N06-0036 DT	2/9/06	dr	L.POTTEIGER	8/30/95			dwg no sheet 1 of 2 size	
J	ELX-N-007928 SH	2011-11-18	eng	Y.BELOPOLSKY	8/30/95			95679 A4	
K	ELX-N-011015 SH	03/27/12	chr	Y.BELOPOLSKY	8/30/95			type Product Customer Drawing	
			app	Y.BELOPOLSKY	8/30/95				
sheet index	revision	K	K						
	sheet	1	2						

PRODUCT No.	PORTS No	DIM A <sup>+0.60</sup> / <sub>-0.00</sub>	DIM B ±0.20	DIM C ±0.10	DIM D ±0.15	COMMENT
95679-X01/X01LF	1	15.24	-----	5.715	11.43	
95679-X02/X02LF	2	30.48	13.97	12.700	25.40	
95679-X03/X03LF	3	44.45	27.94	19.685	39.37	
95679-X04/X04LF	4	58.42	41.91	26.670	53.34	
95679-X05/X05LF	5	72.39	55.88	33.655	67.31	
95679-X06/X06LF	6	86.36	69.85	40.640	81.28	
95679-X06P/X06PLF						NOTE 4
95679-X07/X07LF	7	100.33	83.82	47.625	95.25	
95679-X08/X08LF	8	114.30	97.79	54.610	109.22	
95679-X09/X09LF	9	128.27	111.76	61.595	123.19	NO MOULD
95679-X10/X10LF	10	142.24	125.73	68.580	137.16	NO MOULD
95679-X11/X11LF	11	156.21	139.70	75.565	151.13	NO MOULD
95679-X12/X12LF	12	170.18	153.67	82.550	165.10	NO MOULD

NOTES:

1. APPLICABLE PC BOARD THICKNESS: 1.6 mm.
2. CONTACTS: PHOSPHOR BRONZE ALLOY UNS-C51000, Ø0.460 ROUND WIRE, PLATING SEE TABLE.
3. CENTER PEG FOR 8 PORT AND ABOVE.
- ④ OPTIONAL CENTER PEG IN PORT 6 (95679-X06PLF) WITH CENTER PEG (95679-X06LF) WITHOUT CENTER PEG
- ⑤ PART NUMBERS WITH LF IN THE END ARE LEAD FREE.
4. THIS PRODUCT MEETS EUROPEAN UNION DIRECTIVES AN OTHER COUNTRY REGULATION AS DESCRIBED IN GS-22-008.
5. THE HOUSING TEMPERATURE WITHSTAND EXPOSURE TO 260°C PEAK TEMPERATURE FOR 15 SECONDS IN A WAVE SOLDER APPLICATION WITH A 1.5 MM MINIMUM THICK CIRCUIT BOARD. SEE APPLICATION NOTES/PROCEDURES IF THEY ARE AVAILABLE.
- ⑥ PLATING OPTION: MAY BE EITHER GOLD OR GXT PLATED AT MANUFACTURER'S OPTION.
7. PRODUCT SPECIFICATION GS-12-083  
PACKAGING SPECIFICATION GS-14-361



PLATING CODE X	PLATING ⑥
0	5u" Au + high performance lubricant
1	15u" GOLD.
2	15u" G.X.T.
3	5u" Au + high performance lubricant
5	50u" GXT.

mat'l. code	surface ISO 1301 ✓	tolerance ISO406 ISO1101	projection MM	product family MOD JACK
ltr ecn nodr	date	tolerances unless otherwise specified	scale 1.0	title R/A CAT5 GANG JACK ASSY 8 POS UNSHIELDED SNAP PEG
k	angle	0.X±0.3 0.XX±0.13 0.XXX±0.051	MM	dwg no 95679
	0°±2'		scale 1.0	sheet 2 of 2 size A4
	dr L.POTTEIGER	8/30/95		type Product Customer Drawing
	eng Y.BELOPOLSKY	8/30/95		
	chr Y.BELOPOLSKY	8/30/95		
sheet index	revision sheet			